

ANTENNA PRODUCTS

Data sheet

3216 Ceramic Chip Antenna in PIFA Mode for Bluetooth/WLan Application

Preliminary

Jul. 2009.

R&D	Print date 10/10/07						
	3216 Ceramic Chip Antenna (PIFA Mode) for Bluetooth/WLan Application			Pre	Jul, 2009		
		CAN424	1 122 2V 24E 2K				
		CAN4311 132 2X 245 3K					
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Oscar Lu	Yageo Taiwan / Hi	Yageo Taiwan / High Frequency Ceramic Department					



3216 Ceramic Chip Antenna for Bluetooth/WLAN Application

Product Specification

Quick Reference Data

Centre Frequency 2.45 GHz

Bandwidth 2.4 ~ 2.484GHz

Polarization Linear

Azimuth Beamwidth Omni-directional

Peak Gain 2.84 dBi

Impedance 50Ω

Operating Temperature -25~85 °C

Termination Ni / Sn (Environmentally-Friendly Leadless)

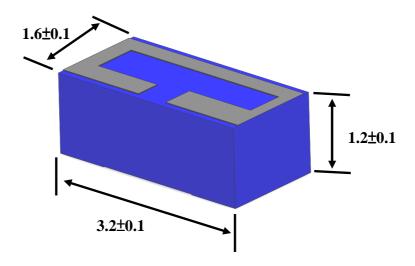
Resistance to soldering heats 260° C, 10sec.

Maximum Power 1W

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	3216 Ceramic Chip Antenna (PIFA Mode) for						
	Bluetooth/WLan Application	CAN431	1 132 2X 243 3K				
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1. Mechanical Data (3.2 x 1.6x 1.2 mm³)



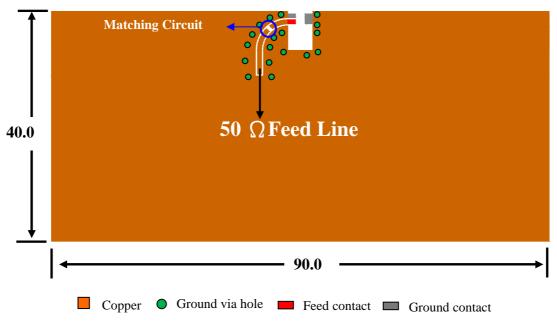
Unit: mm

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	3216 Ceramic Chip Antenna (PIFA Mode) for	CAN4311 132 2X 245 3K					
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			.				
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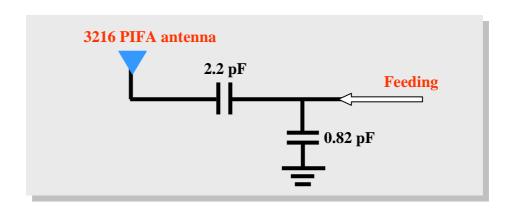
2. Evaluation Board Dimension and Outlook

■ Illustration of Evaluation Board



Unit: mm

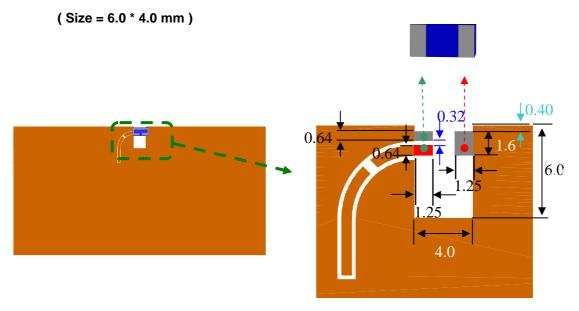
■ Suggested Matching Circuit :



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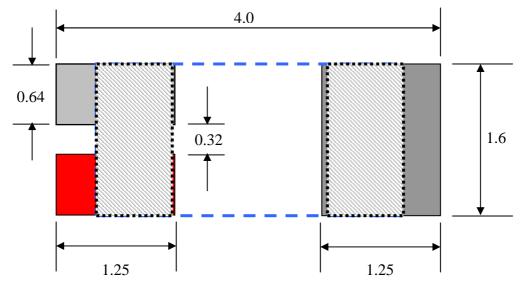


■ Clearance Definition:



Unit: mm

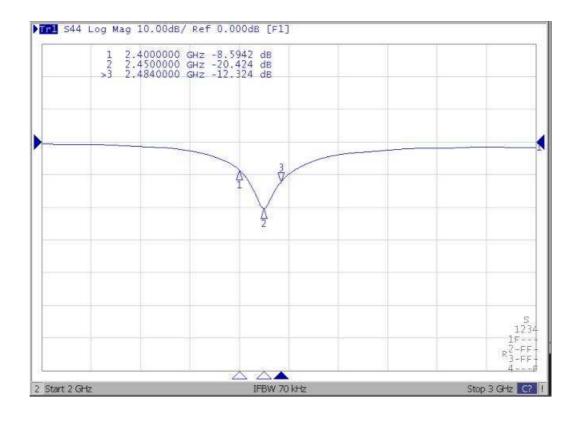
■ Soldering Pads Dimension and Footprint :



Tol: ±0.2 Unit: mm

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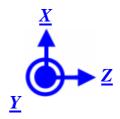
3. Measured S-parameter

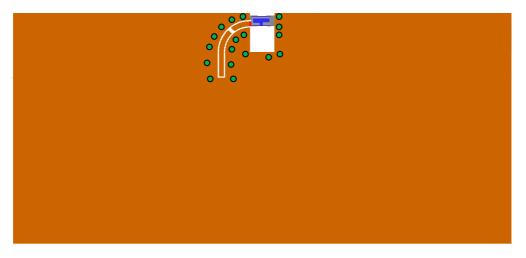


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4.The Definition of X-Y-Z Plane

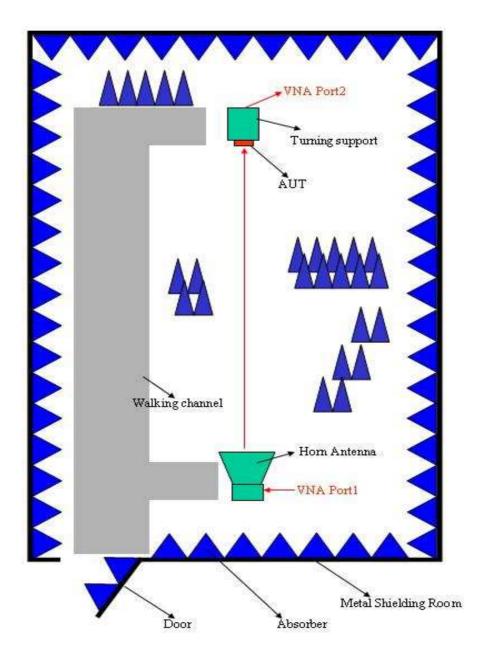




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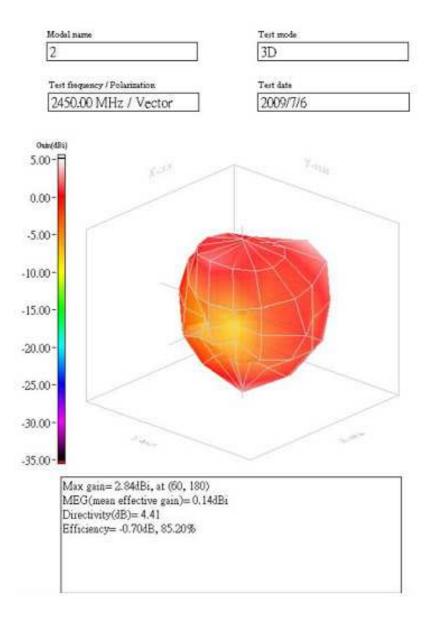
5. The Environment of Antenna Radiation Pattern Anechoic Chamber Dimension= $10(m) \times 6(m) \times 6(m)$



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6. Radiation Pattern



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7. Reliability Test

IEC 384-10/ CECC 32 100 CLAUSE	IEC 60068-2 TEST METHO D	TEST	PROCEDURE	REQUIREMENTS
4.4		Mounting	The antenna can be mounted on printed-circuit boards or ceramic substrates by applying wave soldering, reflow soldering (including vapour phase soldering) or conductive adhesive	No visible damage
4.5		Visual inspection and dimension check	Any applicable method using x 10 magnification	In accordance with specification (chip off 4mm)
4.6.1		Antenna	Central Frequency at 20 ^O C	Standard test board in page 4
4.8		Adhesion	A force of 3 N applied for 10 s to the line joining the terminations and in a plane parallel to the substrate	No visible damage
4.9		Bond strength of plating on end face	Mounted in accordance with CECC 32 100, paragraph 4.4	No visible damage
			Conditions: bending 0.5 mm at a rate of 1mm/s, radius jig. 340 mm, 2mm warp on FR4 board of 90 mm length	No visible damage

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IEC 384-10/ CECC 32 100 CLAUSE	IEC 60068-2 TEST METHO D	TEST	PROCEDURE	REQUIREMENTS
4.10	20(Tb)	Resistance to soldering heat	260 ± 5 °C for 10 ± 0.5 s in a static solder bath	Satisfy the original electrical specification after soldering.
		Resistance to leaching	260 ± 5 °C for 30 ± 1 s in a static solder bath	Using visual enlargement of x 10, dissolution of the termination shall not exceed 10%
4.11	20(Ta)	Solderability	Zero hour test, and test after storage (20 to 24 months) in original atmosphere; un-mounted chips completely immersed for 2 ± 0.5 s in 235 ± 5°C.	The termination must be well tinned, at least 75% is well tinned at termination
4.12	4(Na)	Rapid change of temperature	-25 °C (30 minutes) to +85 °C (30 minutes); 100 cycles	No visible damage Central Freq. Change ± 6%
4.14	3(Ca)	Damp heat	500 ± 12 hours at 60 °C; 90 to 95 % RH	No visible damage 2 hours recovery Central Freq. Change ± 6%
4.15		Endurance	500 ± 12 hours at 85 °C;	No visible damage 2 hours recovery Central Freq. Change ± 6%

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8. Ordering Information

The antennas may be ordered by using the Yageo ordering code. These code numbers can be determined by the following rules:

F, Family Code

CAN 43 = Yageo Part No. for Antenna

C, Packing Type Code

11 = 180 mm/7" reel, blister taping

M, Materials Code

1 = High Frequency Material (blue)

S, Size Code

32 = 3.2* 1.6mm (thickness = 1.2 mm)

T, Antenna type

21 = type 1

A, Working Frequency

245 = for application band around 2.4~2.5GHz

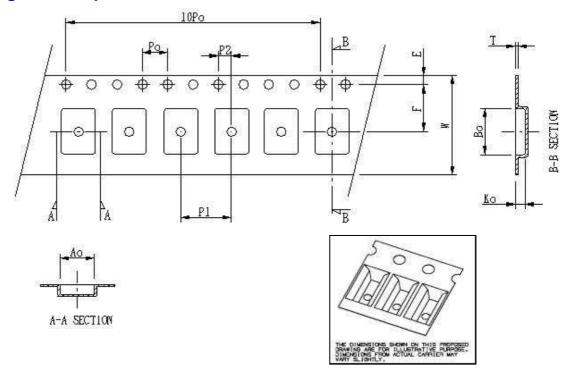
P, Packing quantity

3K = 3000 pcs in one reel.

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9. Taping Blister Tape

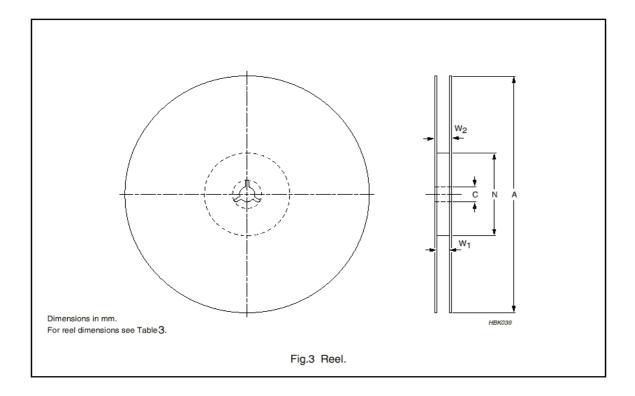


Serial no	Checking note	Index	Spec(mm)
1	Sprocket hole	Do	1.50±0.10
2	Pocket hole	D1	1.0±0.05
3	Distance sprocket hole/sprocket hole	Po	4.0±0.10
4	Distance pocket/pocket	P1	4.0±0.10
5	Distance sprocket hole/pocket	P2	2.0±0.05
6	Tape width	W	12.0±0.30
7	Distance sprocket hole/outside	E	1.75±0.10
8	Distance sprocket hole/pocket	F	5.50±0.05
9	Pocket length	Ao	1.47±0.20
10	Pocket length	Во	3.4±0.20
11	Pocket depth	Ko	1.8±0.20
12	Thickness of tape	Т	0.279±0.02
13	10x sprocket hole pitch	10Po	40.0±0.20

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10. Taping Reel - 7"(180mm) Specifications



Units per Reel	Tape Width (mm)	A (mm)	N (mm)	C (mm)	W ₁ (mm)	W ₂ Max (mm)
3000	12	180.0±1.0	60±1	13 ^{+0.5} /-0.2	12.4 ^{+2.0} / _{-0.0}	18.4

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11. Tape Revision Control:

Date	Content	Remark
7 th ,Jul, 2009	New issued	

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